

4

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C

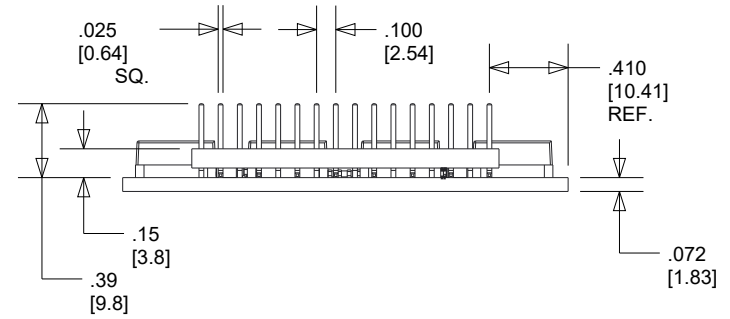
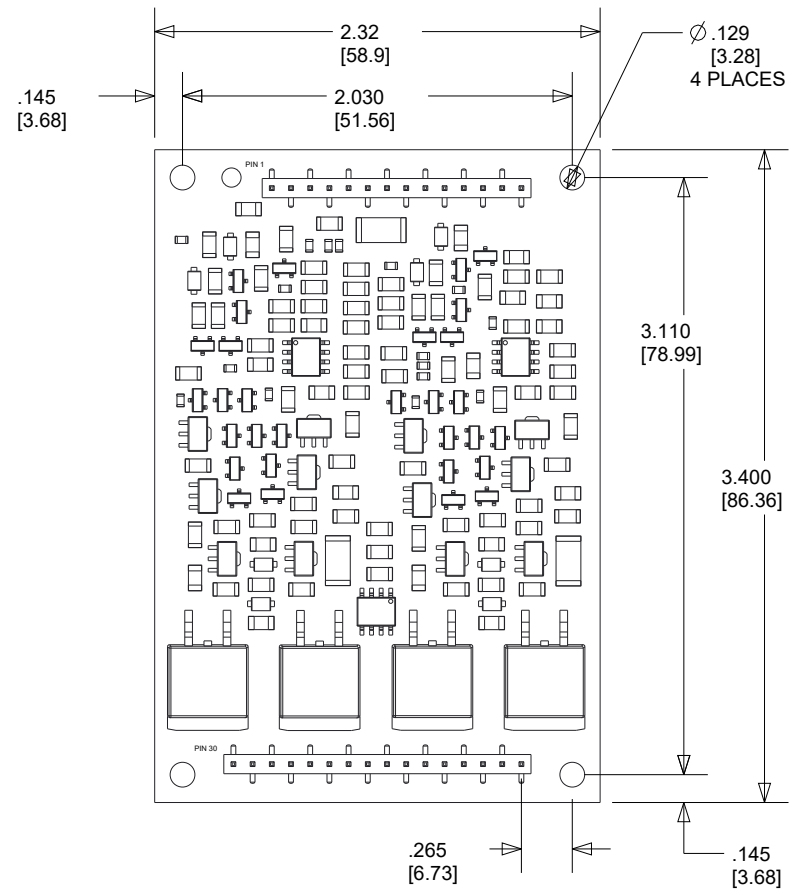
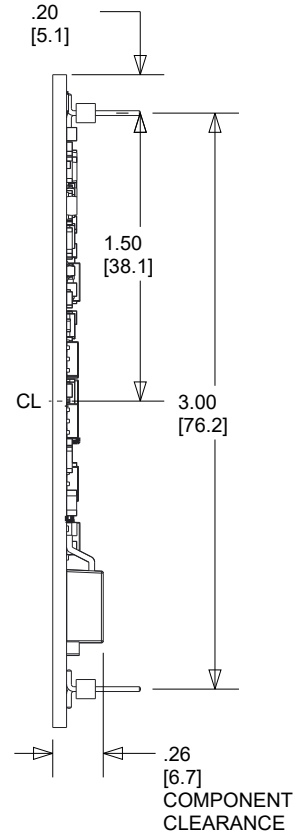
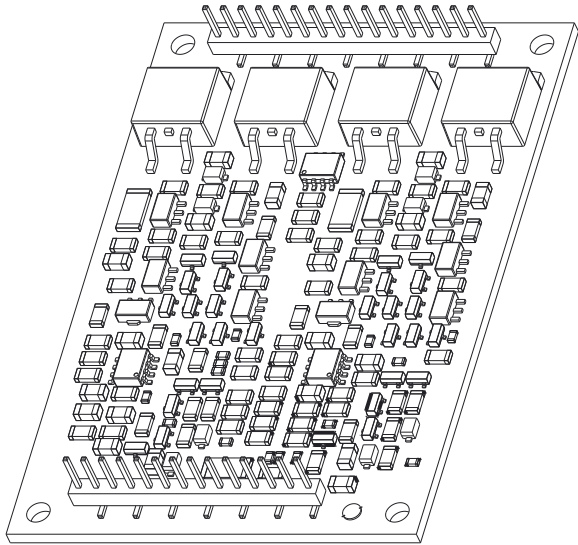
C

B

B

A

A



- NOTES:
1. Dimensions are in inches [mm].
 2. Recommended PCB hole diameter for pins: 0.050 [1.27].
 4. 2oz. copper over 600V dielectric over aluminum substrate.
 5. Tin over nickel plated phospher bronze pins.
 6. It is not recommended that mounting of the package rely on the pins for mechanical support.
 7. Use #4 or equivalent screws to mount to heat sink.
 8. Package Weight: 35 grams.

TOLERANCES - UNLESS OTHERWISE SPECIFIED
 .XX = +/- .05" [1.27]
 .XXX = +/- .005" [0.127]
 ANG. = +/- 2 DEGREES



TITLE: 30-PIN MODULAR DIP, 3.0" SPACING
 SUBJECT: PACKAGE OUTLINE
 ENGINEER: AA DRAWN BY: EAS DCA: 19046 SH. 1 OF 1

MODEL: KP
 FILENAME: KP REV: A DATE: 13FEB19

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